

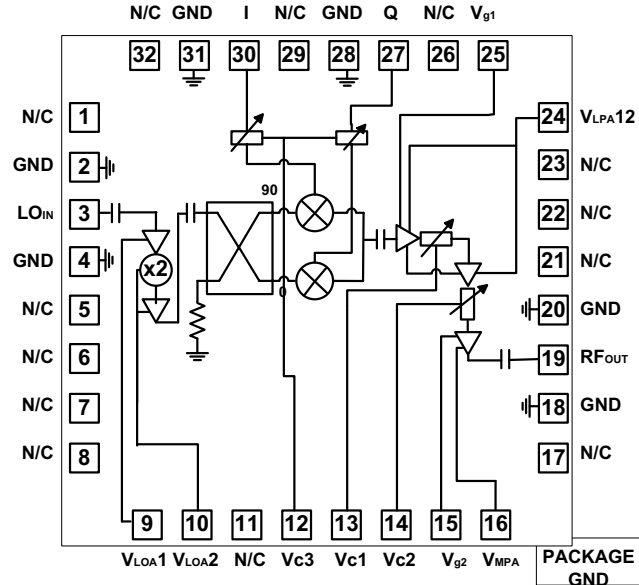


Features

- RF Frequency: 21GHz to 26.5GHz
- LO Frequency (LSB): 10.5GHz to 15.2GHz
- LO Frequency (USB): 8.5GHz to 13.25GHz
- IF Frequency: DC to 4GHz
- Conversion Gain (Max): 21dB
- Conversion Gain (Min): -10dB
- NF (Max. Gain): 9dB
- OIP3 (Max. Gain): +27dBm
- Image Rejection: 15dBc

Applications

- Point-to-Point
- VSAT



Functional Block Diagram

Product Description

RFMD's RFUV1703 is a 21GHz to 26.5GHz GaAs pHEMT upconverter, incorporating an integrated doubler, LO buffer amplifier, a balanced single sideband (image rejection) mixer followed by Variable Gain Amplifier, DC decoupling capacitors. The combination of high performance part and low-cost packaging makes the RFUV1703 a cost effective solution, ideally suited to both current and next generation point-to-point and VSAT applications. RFUV1703 is packaged in a 5mm x 5mm QFN to simplify both system level board design and volume assembly.

Ordering Information

RFUV1703S2	2-Piece Sample Bag
RFUV1703SB	5-Piece Bag
RFUV1703SQ	25-Piece Bag
RFUV1703SR	100 Pieces on 7" reel
RFUV1703TR7	750 Pieces on 7" reel
RFUV1703PCBA-410	Evaluation Board

Optimum Technology Matching® Applied

- | | | | |
|--------------------------------------|--------------------------------------|--|------------------------------------|
| <input type="checkbox"/> GaAs HBT | <input type="checkbox"/> SiGe BiCMOS | <input checked="" type="checkbox"/> GaAs pHEMT | <input type="checkbox"/> GaN HEMT |
| <input type="checkbox"/> GaAs MESFET | <input type="checkbox"/> Si BiCMOS | <input type="checkbox"/> Si CMOS | <input type="checkbox"/> BiFET HBT |
| <input type="checkbox"/> InGaP HBT | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si BJT | |

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Absolute Maximum Ratings

Parameter	Rating	Unit
LPA Drain Voltage V_D	6	V
LOA Drain Voltage	6	V
IF Input Power	15	dBm
LO Input Power	15	dBm
T_{OPER}	-40 to +85	°C
T_{STOR}	-65 to +150	°C
ESD Human Body Model	Class 1A	



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

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RFMD Green: RoHS compliant per EU Directive 2002/95/EC, halogen free per IEC 61249-2-21, < 1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

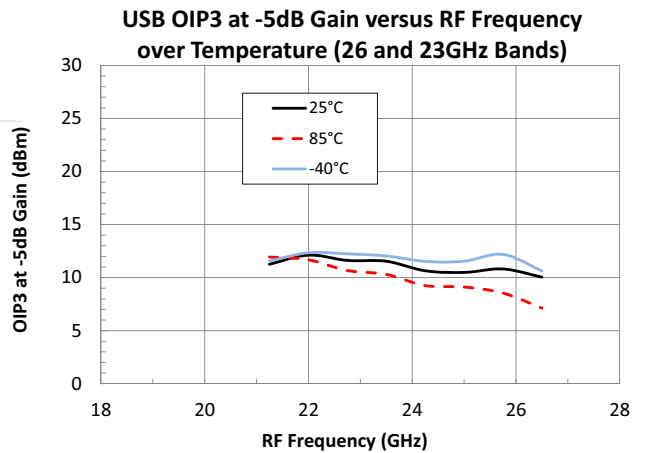
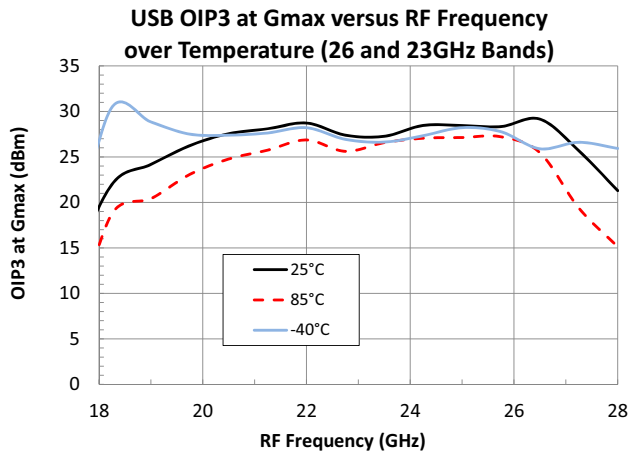
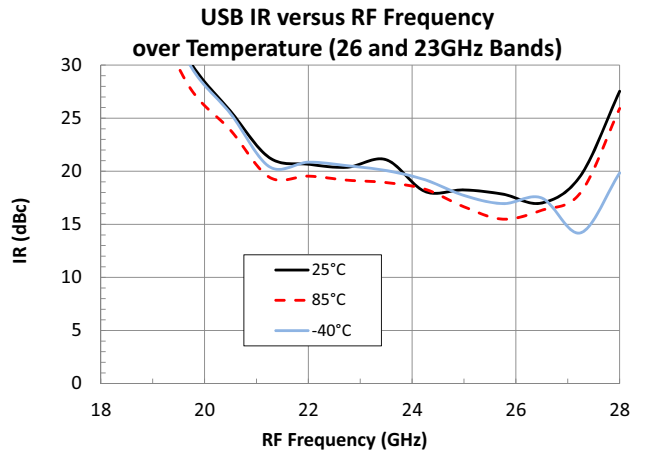
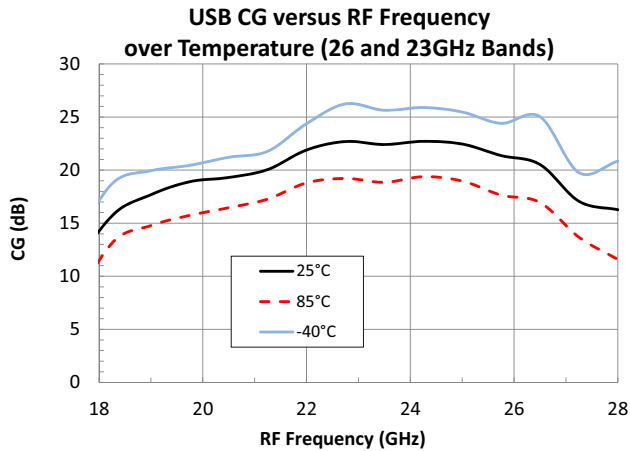
Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
RF Frequency	21		26.5	GHz	
LO Frequency (LSB)	10.5		15.25	GHz	
LO Frequency (USB)	8.5		13.25	GHz	
IF Frequency	DC		4.0	GHz	
LO input Drive		0		dBm	
Conversion Gain (Max.)		21		dB	
Conversion Gain (Min.)		-10		dB	
NF (Max. Gain)		9		dB	
NF (-5dB Gain)		19		dB	
OIP3 (Max. Gain)		27		dBm	
OIP3 (-5dB Gain)		10		dBm	
Image Rejection		15		dBc	
LO Leakage at RF-Port (Max. Gain)		-7		dBm	With IQ bias
LO Return Loss		10		dB	
RF Return Loss		10		dB	
V_D		5		V	
I_D		480		mA	
VVA	-3		0	V	

Typical Electrical Performance

Measurements performed with I and Q (IF) ports connected to an external 90° Hybrid, LO Power = 0dBm and IF = 2.5GHz, -10dBm, unless otherwise stated.

USB Conversion Gain, Image Rejection and OIP3

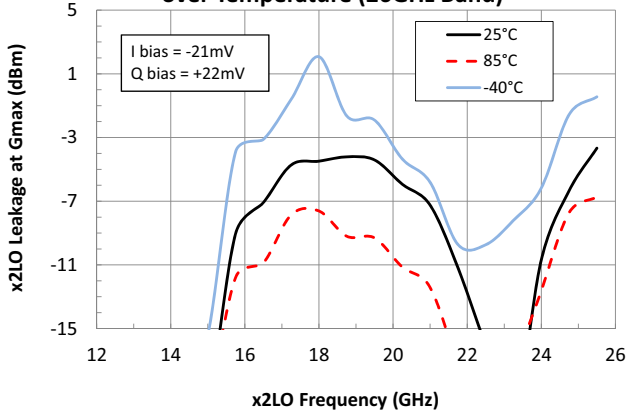
$V_{MPA} = 4.5V, V_{LPA12} = 3.5V, V_{LOA1} = V_{LOA2} = 4V, I_{TOTAL} = 490mA, V_{G1} = -0.2V, V_{C1} = V_{C2} = V_{C3} = -4V$



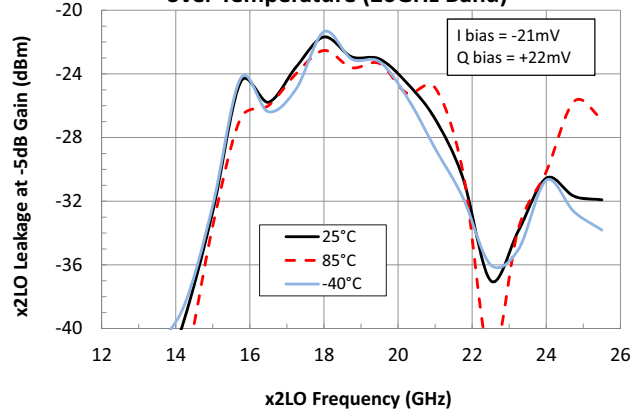
USB LO Leakage

$$V_{MPA} = 4.5V, V_{LPA12} = 3.5V, V_{LOA1} = V_{LOA2} = 4V, I_{TOTAL} = 490mA, V_{G1} = -0.2V, V_{C1} = V_{C2} = V_{C3} = -4V$$

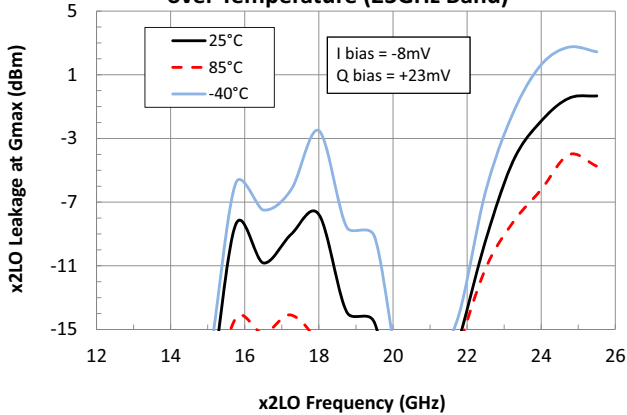
USB x2LO at Gmax versus x2LO Frequency over Temperature (26GHz Band)



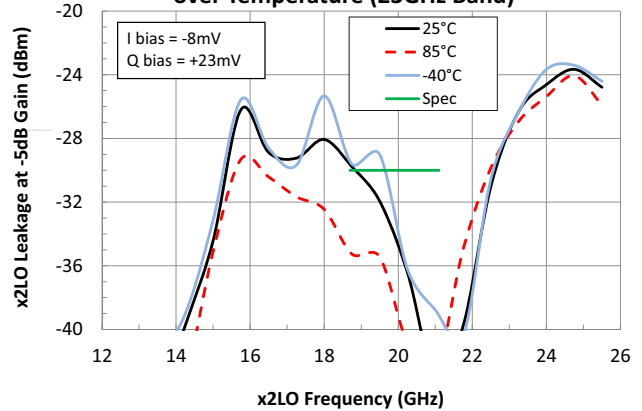
USB x2LO -5dB Gain versus x2LO Frequency over Temperature (26GHz Band)



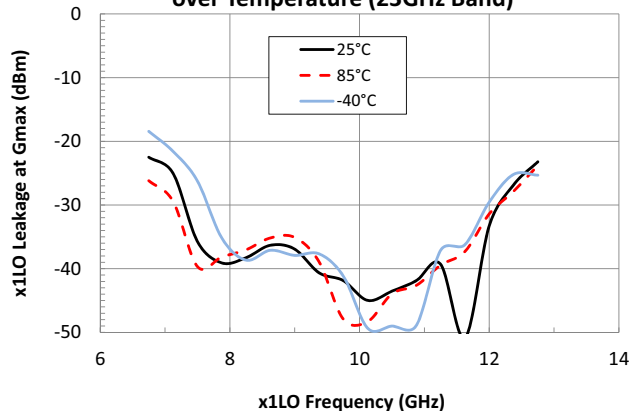
USB x2LO at Gmax versus x2LO Frequency over Temperature (23GHz Band)



USB x2LO -5dB Gain versus x2LO Frequency over Temperature (23GHz Band)

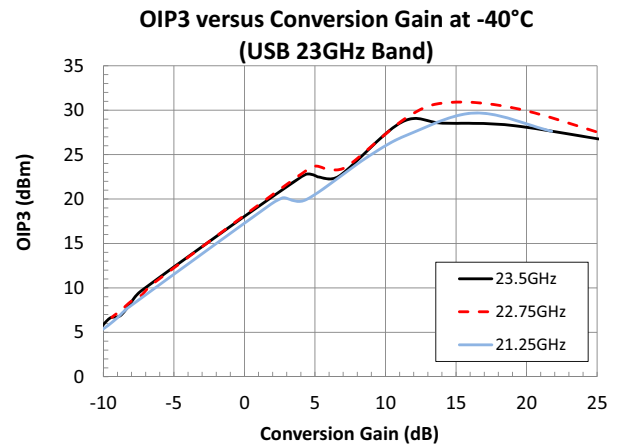
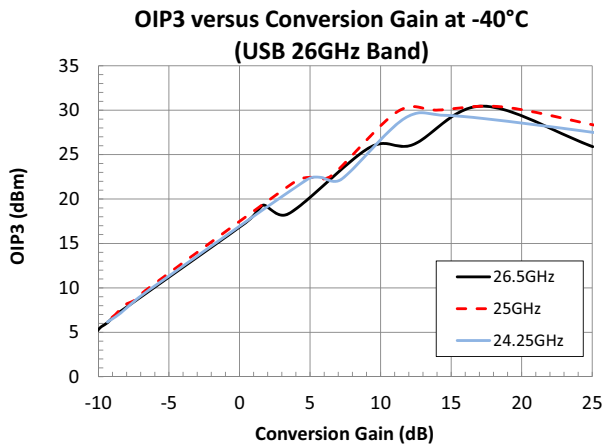
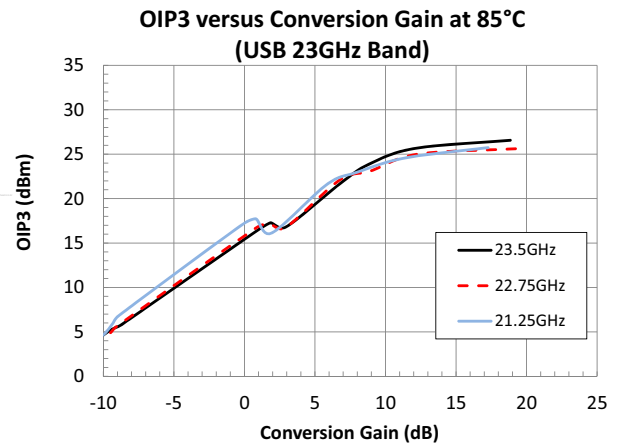
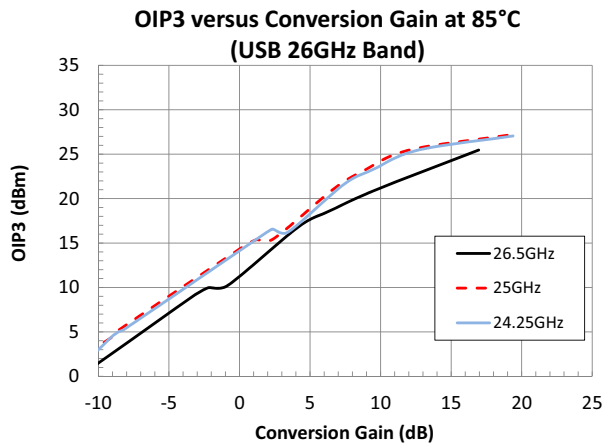
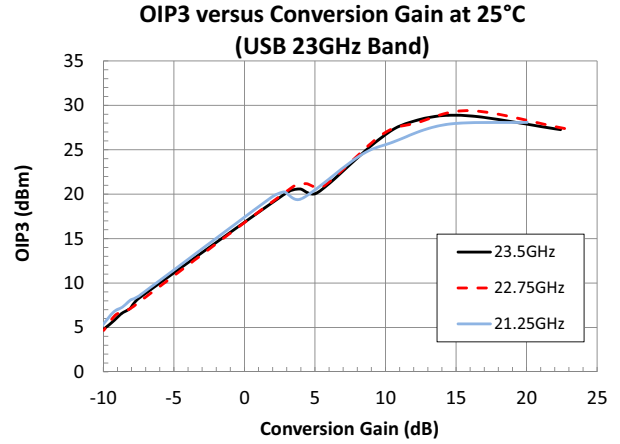
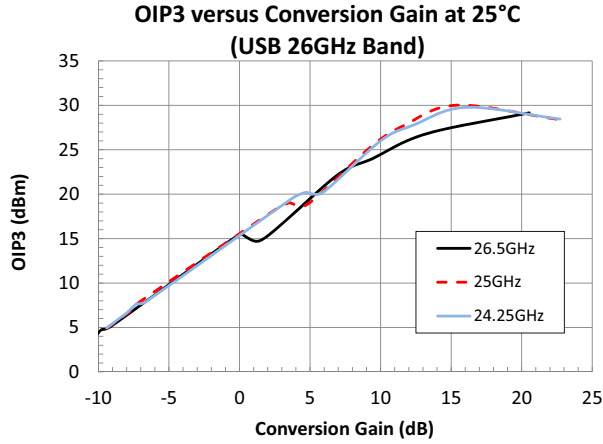


USB x1LO at Gmax versus x1LO Frequency over Temperature (23GHz Band)



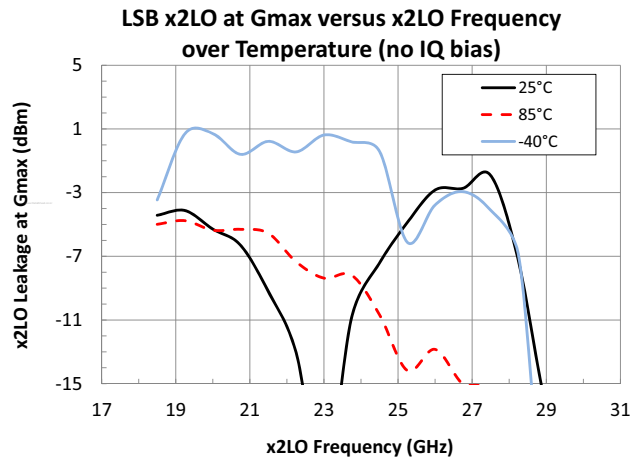
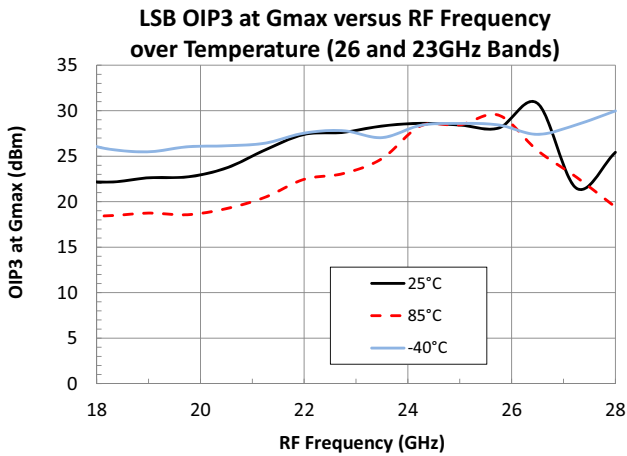
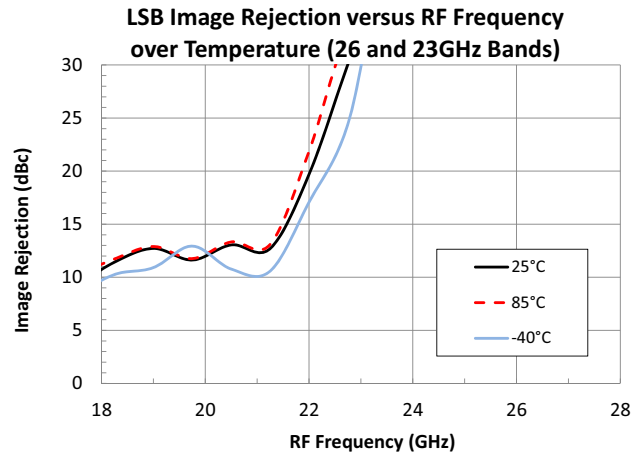
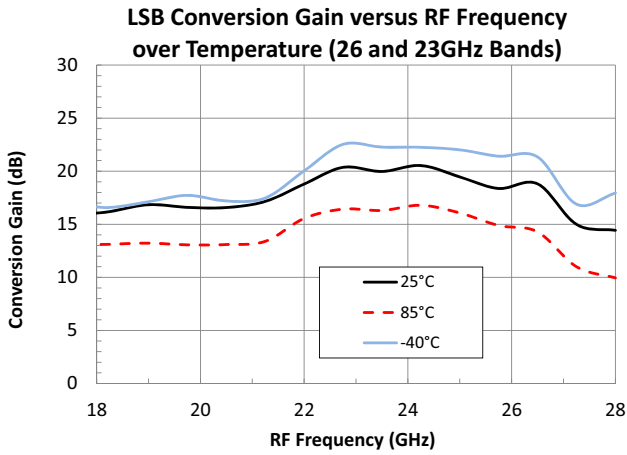
USB OIP3 versus Conversion Gain

$V_{MPA} = 4.5V, V_{LPA12} = 3.5V, V_{LOA1} = V_{LOA2} = 4V, I_{TOTAL} = 490mA, V_{G1} = -0.2V, V_{G2} = -0.4V$ (See bias sequence)



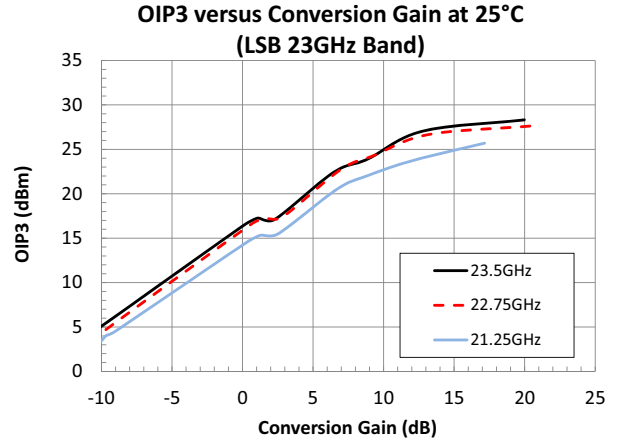
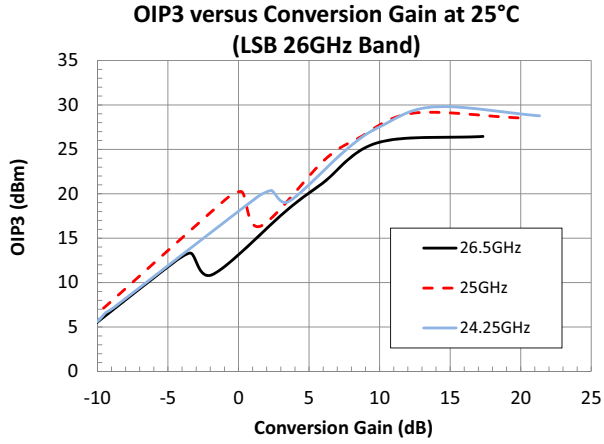
LSB Conversion Gain, Image Rejection OIP3, and x2 LO Leakage

$V_{MPA} = 4.5V, V_{LPA12} = 3.5V, V_{LOA1} = V_{LOA2} = 4V, I_{TOTAL} = 490mA, V_{G1} = -0.2V, V_{G2} = -0.4V, V_{C1} = V_{C2} = V_{C3} = -4V$

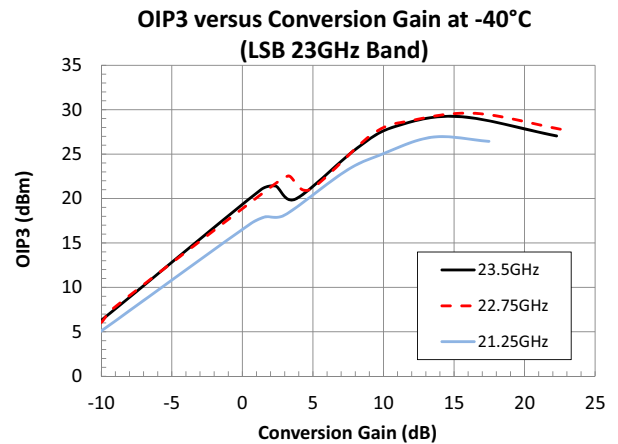
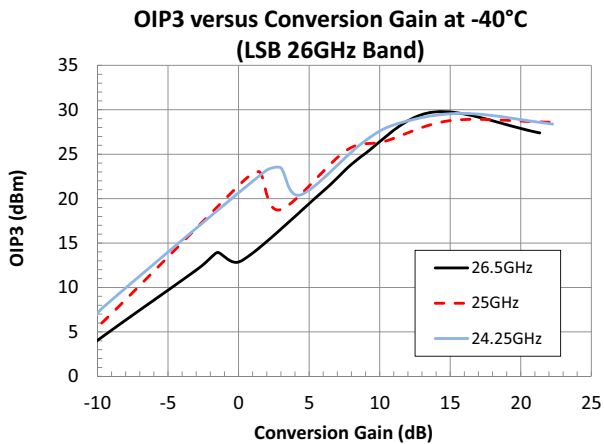
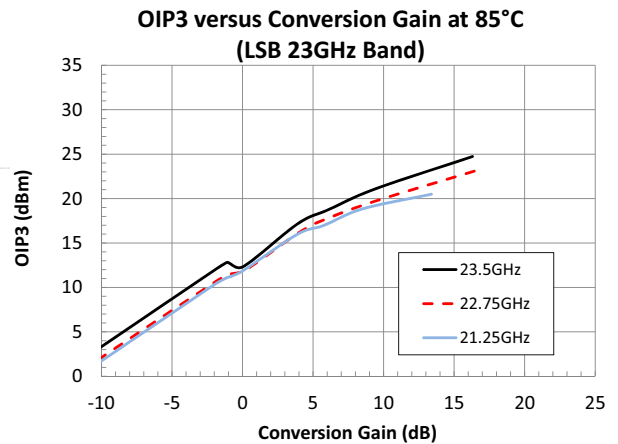
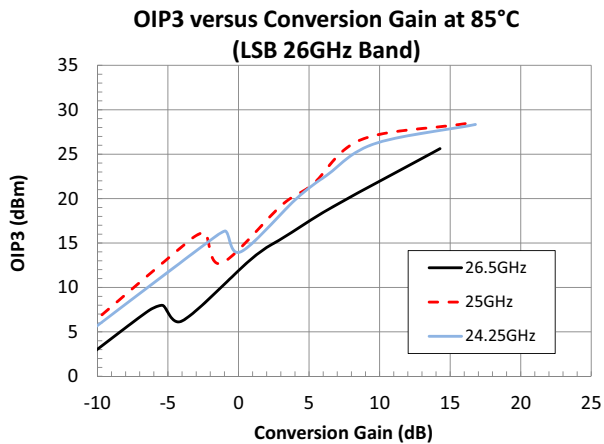


LSB OIP3 versus Conversion Gain

$V_{MPA} = 4.5V, V_{LPA12} = 3.5V, V_{LOA1} = V_{LOA2} = 4V, I_{TOTAL} = 490mA, V_{G1} = -0.2V, V_{G2} = -0.4V$ (See bias sequence)



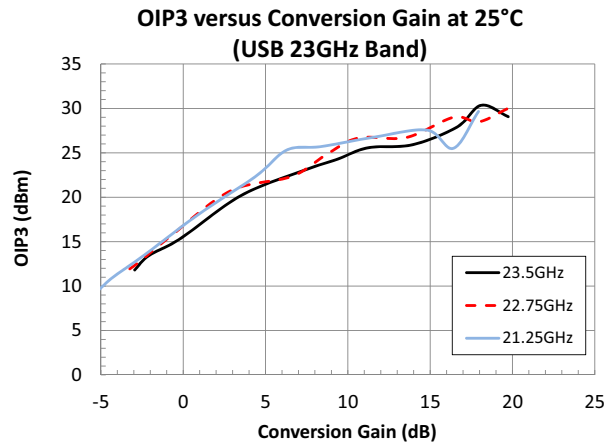
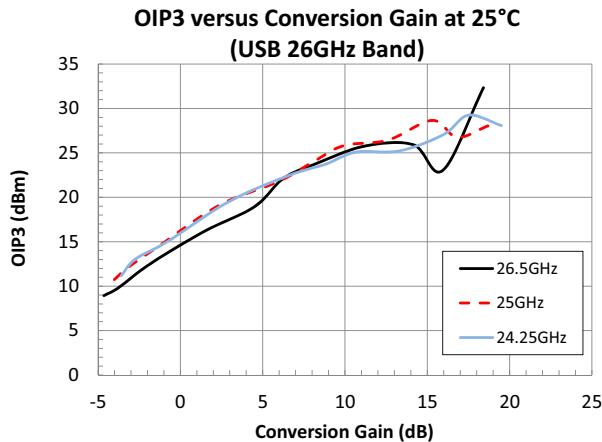
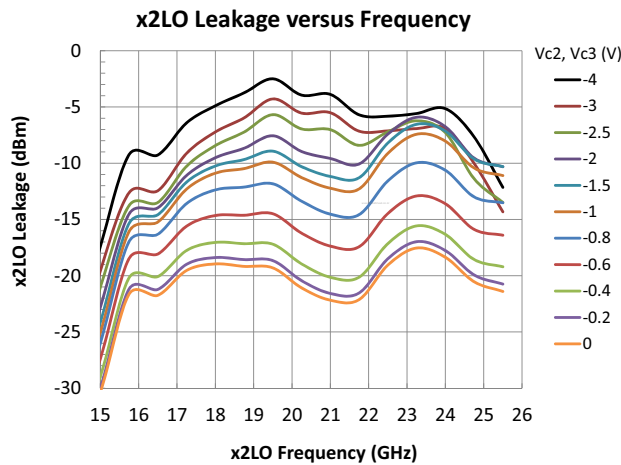
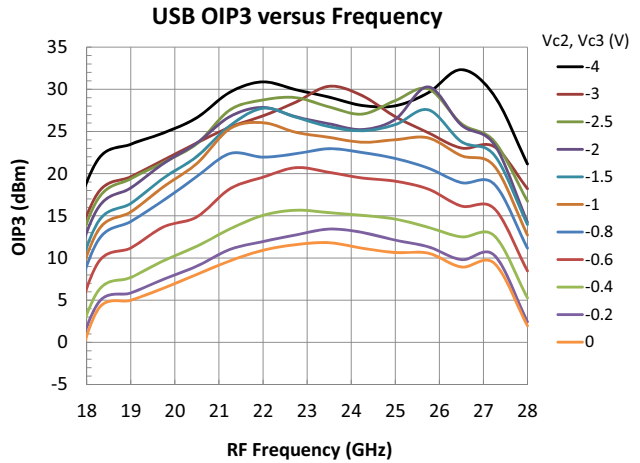
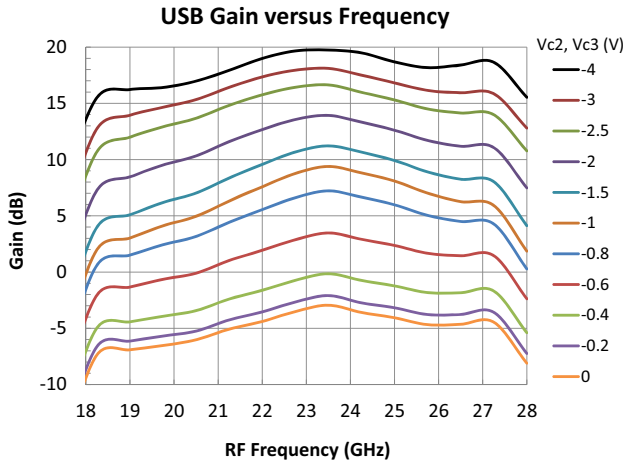
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Performance Using Single Control Line (without IQ Bias) ...1

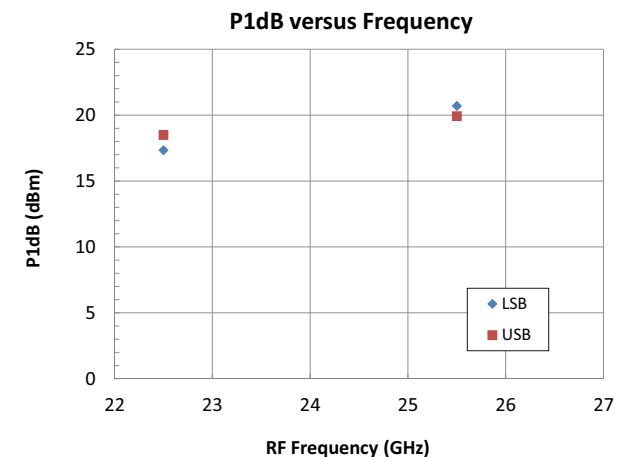
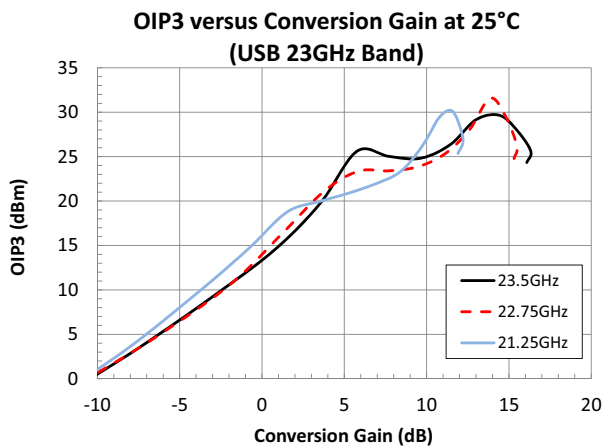
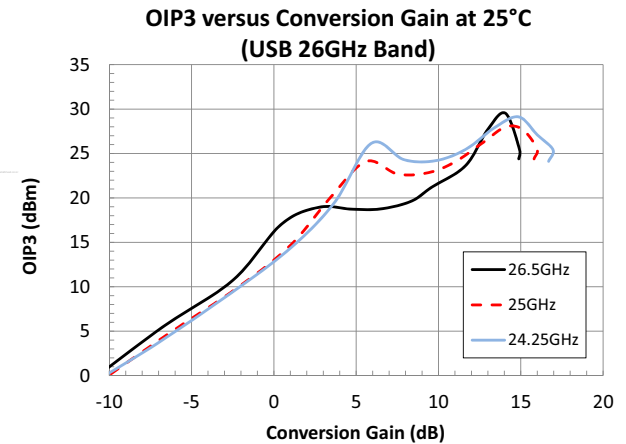
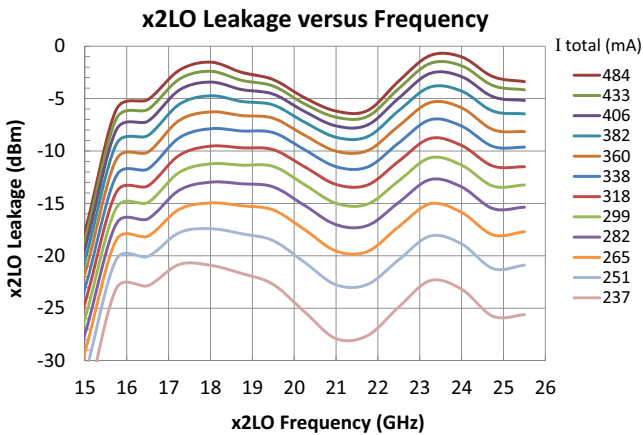
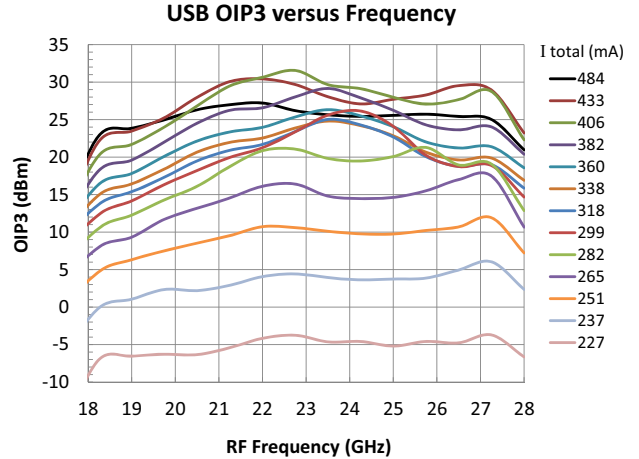
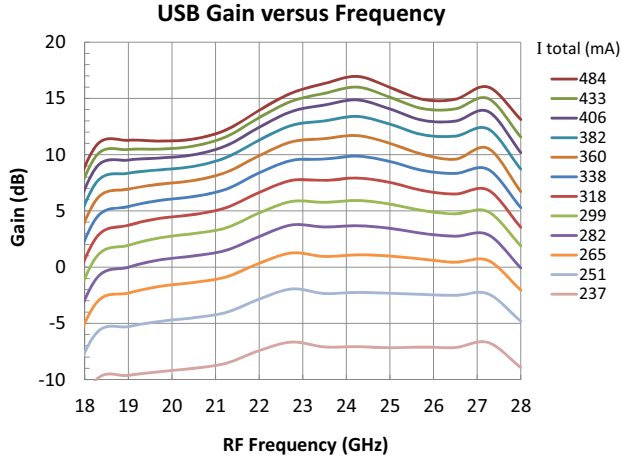
$V_{MPA} = 4.5V$, $V_{LPA12} = 3.5V$, $V_{LOA1} = V_{LOA2} = 4V$, $I_{TOTAL} = 490mA$, $V_{G1} = V_{G2} = -0.4V$, $V_{C1} = -4V$

V_{C2} and V_{C3} are connected together off chip and changes over (-4V to 0V)



Performance Using Single Control Line (without IQ bias)... 2

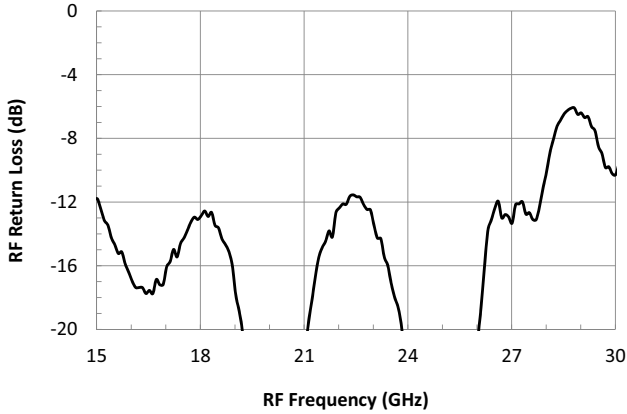
$V_{MPA} = 4.5V$, $V_{LPA12} = 3.5V$, $V_{LOA1} = V_{LOA2} = 4V$, $V_{C1} = V_{C2} = -4V$, $V_{C3} = 0V$
 V_{G1} and V_{G2} are connected together off chip and changes over (-0.3V to -1V)



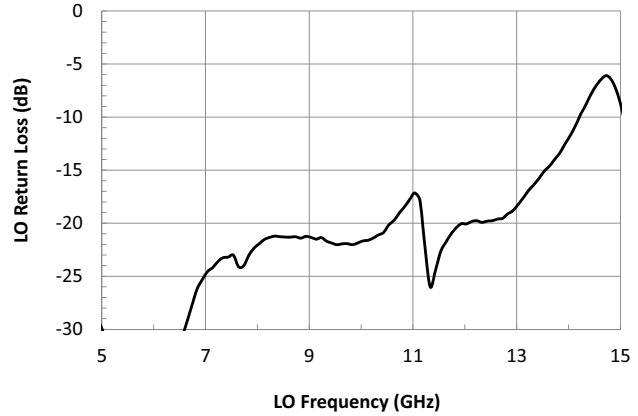
Return Losses

$V_{MPA} = 4.5V, V_{LPA12} = 3.5V, V_{LOA1} = V_{LOA2} = 4V, I_{TOTAL} = 490mA, V_{G1} = -0.2V, V_{G2} = -0.4V, V_{C1} = V_{C2} = V_{C3} = -4V$

RF Return Loss versus RF Frequency



LO Return Loss versus LO Frequency



Bias Sequence and Gain Control

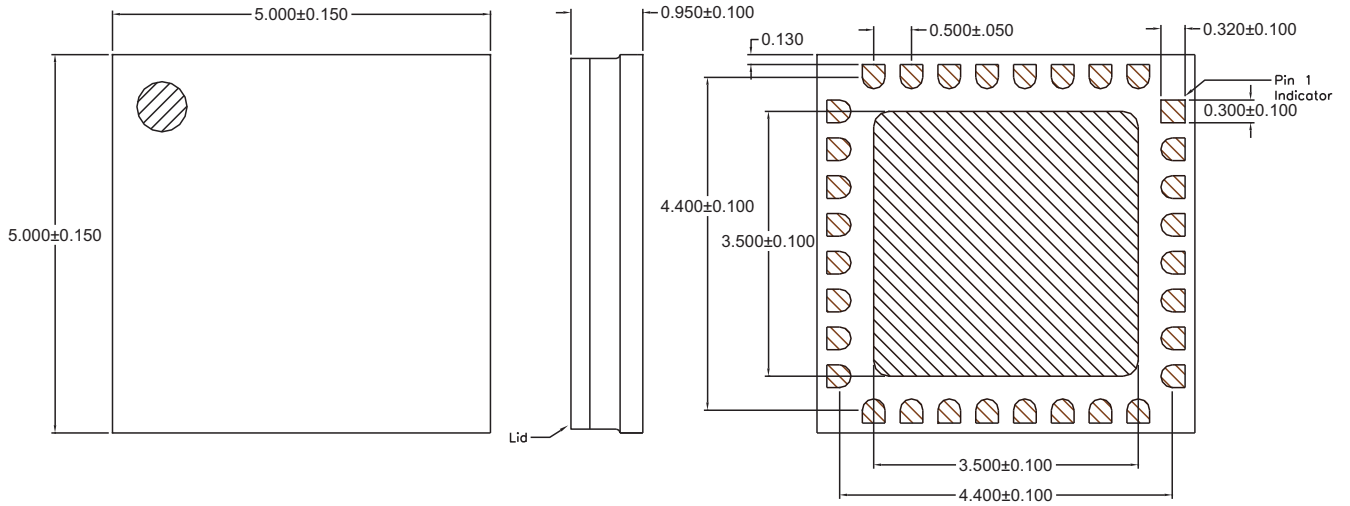
Optimum performance is achieved using sequential bias. At maximum gain (V_{C1}, V_{C3}), and V_{C2} are set at -4V and V_{G2} is set at -0.4V. (V_{C1}, V_{C3}), V_{C2} and V_{G2} are biased in sequence. The first dynamic range is achieved by setting (V_{C2} at -4V and V_{G2} at -0.4V) and varying (V_{C1}, V_{C3}) over the (-4 to -1V) range as shown in the table below. Similarly, the second dynamic range is achieved by setting (V_{C1}, V_{C3}) at -1V, V_{G2} at -0.4V and varying V_{C2} over the (-4 to -0.3V) range. Finally, the third dynamic range is achieved by setting (V_{C1}, V_{C3}) at -1V, V_{C2} at -0.3V and varying V_{G2} over the (-0.4 to -1V) range.

Test Conditions and Bias Sequence

$V_{MPA} = 4.5V, V_{LPA12} = 3.5V, V_{LOA1} = V_{LOA2} = 4V, I_{TOTAL} = 490mA, V_{G1} = -0.2V, V_{C1} = V_{C2} = V_{C3} = -4V$

Bias Sequence										
	G_{MAX}									G_{MIN}
(V_{C1}, V_{C3})	-4	-2	-1	-1	-1	-1	-1	-1	-1	-1
V_{C2}	-4	-4	-4	-2	-1	-0.3	-0.3	-0.3	-0.3	-0.3
V_{G2}	-0.4	-0.4	-0.4	-0.4	-0.4	-0.4	-0.6	-0.8	-0.9	-1

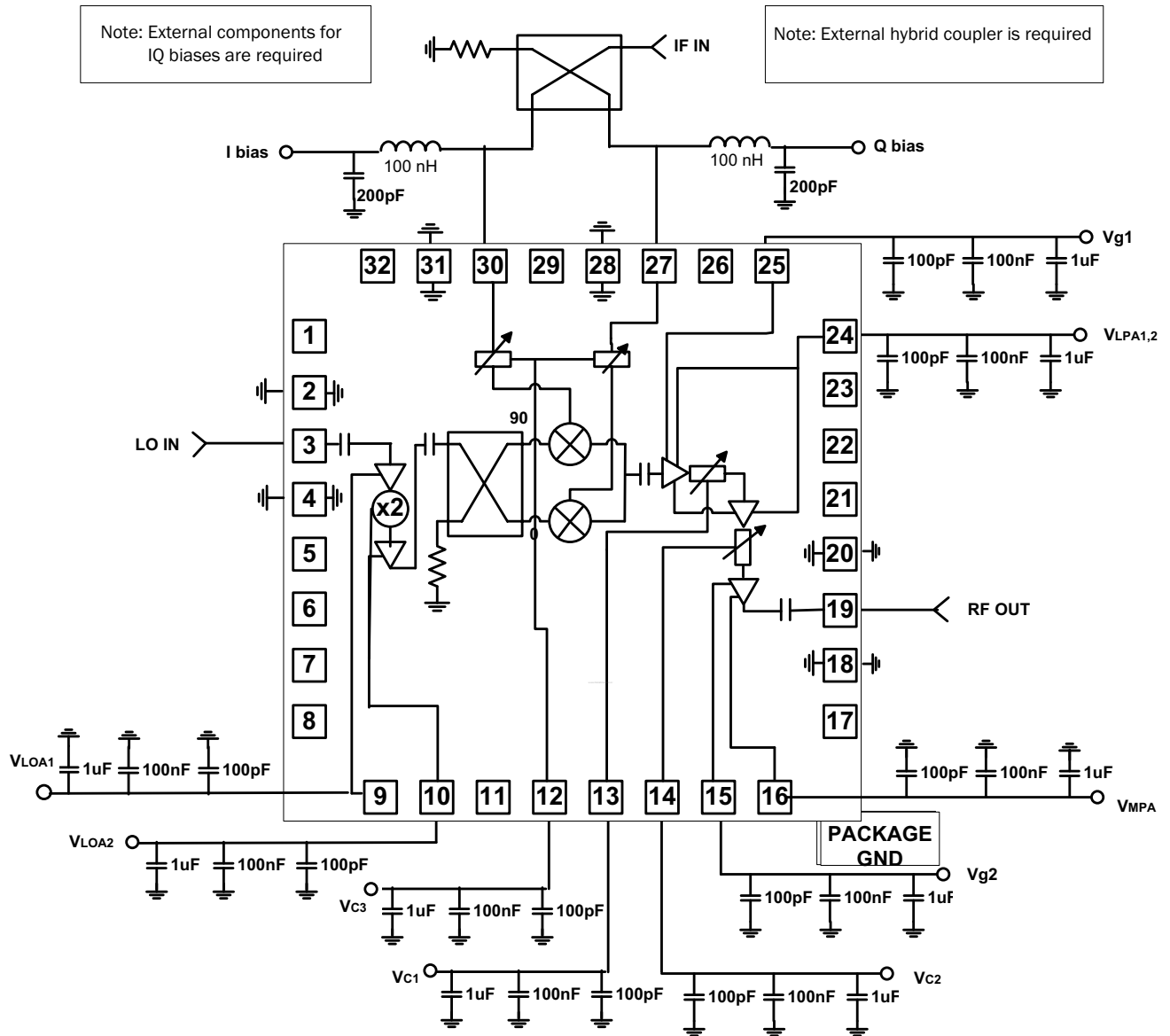
Package Outline Drawing
 QFN, 32-Pin, 5mm x 5mm x 0.95mm



Pin Names and Description

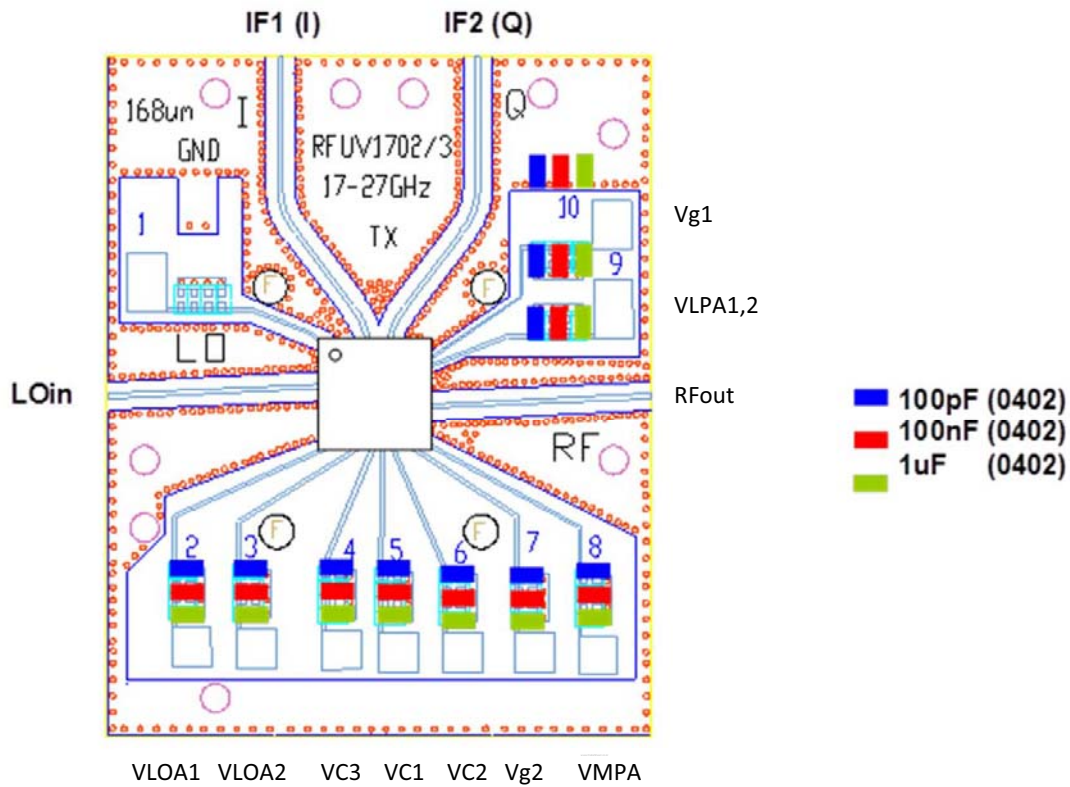
Pin	Function	Description
1	N/C	Not Connected
2	GND	Ground
3	LO	Local Oscillator Input. AC Coupled and Matched to 50Ω
4	GND	Ground
5	N/C	Not Connected
6	N/C	Not Connected
7	N/C	Not Connected
8	N/C	Not Connected
9	VLOA1	LOA Stage1 Drain Bias
10	VLOA2	LOA Stage2 Drain Bias
11	N/C	Not Connected
12	VC3	Control Line Number 3 (See Bias Sequence Description)
13	VC1	Control Line Number 1 (See Bias Sequence Description)
14	VC2	Control Line Number 2 (See Bias Sequence Description)
15	VG2	MPA Gate Bias
16	VMPA	MPA Drain Bias
17	N/C	Not Connected
18	GND	Ground
19	RFOUT	RF Output. AC Coupled and Matched to 50Ω
20	GND	Ground
21	N/C	Not Connected
22	N/C	Not Connected
23	N/C	Not Connected
24	VLPA1, VLPA2	LPA Stage 1, 2 Drain Bias
25	VG1	LPA Stage 1, 2 Gate Bias
26	N/C	Not Connected
27	Q	IF Q Input
28	GND	Ground
29	N/C	Not Connected
30	I	IF I Input
31	GND	Ground
32	N/C	Not Connected

Application Circuit Block Diagram



2*LO - IF = RF (LSB), LO = 10.5 to 15.25GHz
 2*LO + IF = RF (USB), LO = 8.5GHz to 13.25GHz

Evaluation Board Layout



Test Condition

LO Power	0dBm
IF Power	-10dBm
VMPPA	4.5V
VLPA1, VLPA2	3.5V
VLOA1, VLOA2	4V
V _{C1} , V _{C3}	-4V to 1V
V _{C2}	-4V to 0.3V
V _{G1}	-0.2V
V _{G2}	-0.4V to 1V

Sub-Band Frequency Ranges

Band	Frequency Range
23GHz	21.2GHz to 23.6GHz
26GHz	24.5GHz to 26.5GHz